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10/522887



RECORDATION FORM COVER SHEET

Attorney Docket No.: 0055/076001

103281099

PATENTS ONLY

Commissioner of Patents and Trademarks: Please record the attached copies of an original document.

1. Name of conveying party(ies):

Takeshi KUSUSE
Takahiko SAKAMOTO

Additional name(s) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Nichia Corporation
491-100 Oka, Kaminaka-cho
Anan-shi, Tokushima-ken
774-8601 JAPAN

Additional names/addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment
☐ Merger
☐ Security Agreement
☐ Change of Name
☐ Other:

Execution Date: November 14, 2005

4. Application number(s) or patent number(s): 10/522,887

If this document is being filed with a new application, the execution date of the application is:

A. Patent Application No.(s): 10/522,887

B. Patent No.(s):

Additional numbers attached? ☐ Yes ☒ No

10/522887

5. Name/address of party to whom correspondence concerning document should be mailed:

Randolph A. Smith
SMITH PATENT OFFICE
1901 Pennsylvania Ave., N.W.
Suite 901
Washington, D.C. 20006-3433

6. Total number of applications/patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41): \$40

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

- a) Credit Card Last 4 Numbers: 1006
Expiration Date: July 2007
b) Please apply any additional charges, or any credits, to our Deposit Account No. 19-2586

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9. Statement and signature: To the best of my knowledge and belief, the foregoing information is true and correct and the attached is a true copy of the original document.

Randolph A. Smith
Name of Person Signing

Signature

December 22, 2005
Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign(s), transfer(s) and set(s) over to:

Nichia Corporation

having the address:

491-100 Oka, Kaminaka-cho, Anan-shi
Tokushima-ken 774-8601 JAPAN

(hereinafter collectively designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefore, including said application, and all United States Letters Patents which may be granted therefore, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the Title:

SEMICONDUCTOR LIGHT-EMITTING DEVICE, METHOD FOR
MANUFACTURING THE SAME, AND LIGHT-EMITTING
APPARATUS INCLUDING THE SAME

Attorney Docket No. 0055/076001

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No. 10/522,887

Filing Date: February 1, 2005

1. The undersigned hereby agree(s) to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.

2. The undersigned agree(s) to execute all papers and documents and perform any act that may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

3. The undersigned agree(s) to perform all affirmative acts that may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.

4. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks in the United States to issue any and all Letters Patents resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.

5. The undersigned hereby grant(s) to Randolph A. Smith and Smith Patent Office the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Nov. 14, 2005

Date

Takeshi Kususe

Typed Name: Takeshi KUSUSE

Nov. 14, 2005

Date

Takahiko Sakamoto

Typed Name: Takahiko SAKAMOTO